

# **SPECIFICATION**

**COMMERCIALY AVAILABLE**

**ITEM: DIELECTRIC CERAMIC FILTER**

**PART NUMBER: CF-13201005**

| ISSUED | CHECKED | CHECKED | CHECKED | APPROVED |
|--------|---------|---------|---------|----------|
|        |         |         |         |          |

***FILTRONETICS Inc***

1. APPLICATION

THIS SPECIFICATION APPLIES TO BAND PASS FILTER USING DIELECTRIC RESONATORS.

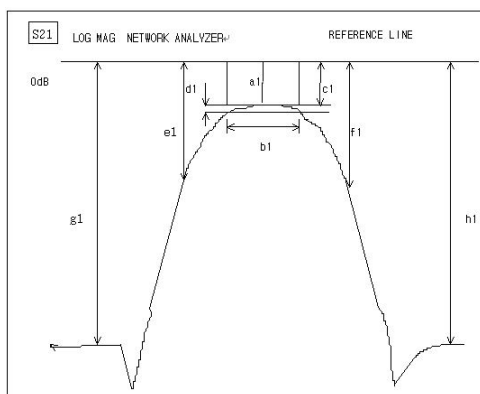
2. PART NUMBER

|           |              |
|-----------|--------------|
| PART NO   | CF-13201005  |
| PACKAGING | PLASTIC TRAY |

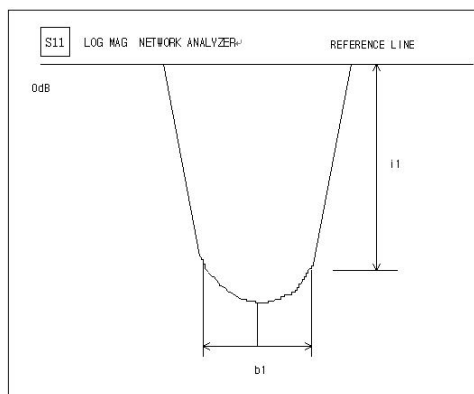
3. SPECIFICATIONS

| NO | ITEMS                               | Ref.        | SPECIFICATION                                 |
|----|-------------------------------------|-------------|---|
| 1  | Center Frequency (Fo)               | a1          | 1320 MHz                                      |
| 2  | 3.0dB Band Width                    | b1          | 100 MHz +/-10%                                |
| 3  | Insertion Loss AT Fo                | a1          | 3.0 dB Max                                    |
| 4  | V.S.W.R AT Fo+/-40MHz               | -           | 1.75:1 Min                                    |
| 5  | Attenuation<br>[absolute value]     | At 1220 MHz | 30 dB Min                                     |
|    |                                     | At 1420 MHz | 25 dB Min                                     |
| 6  | Group Delay Variation AT Fo+/-40MHz | -           | 30ns Max                                      |
| 7  | Impedance                           | -           | 50Ω   |
| 8  | Maximum Input Power                 | -           | 1 W (+30dBm)                                  |
| 9  | Operating Temperature Range         | -           | -35 ~ +85°C                                   |
| 10 | Workmanship                         | -           | IPC-610 class 3                               |
| 11 | Process Temperature                 | -           | +150°C for 1 hour or<br>+230°C for 10 minutes |

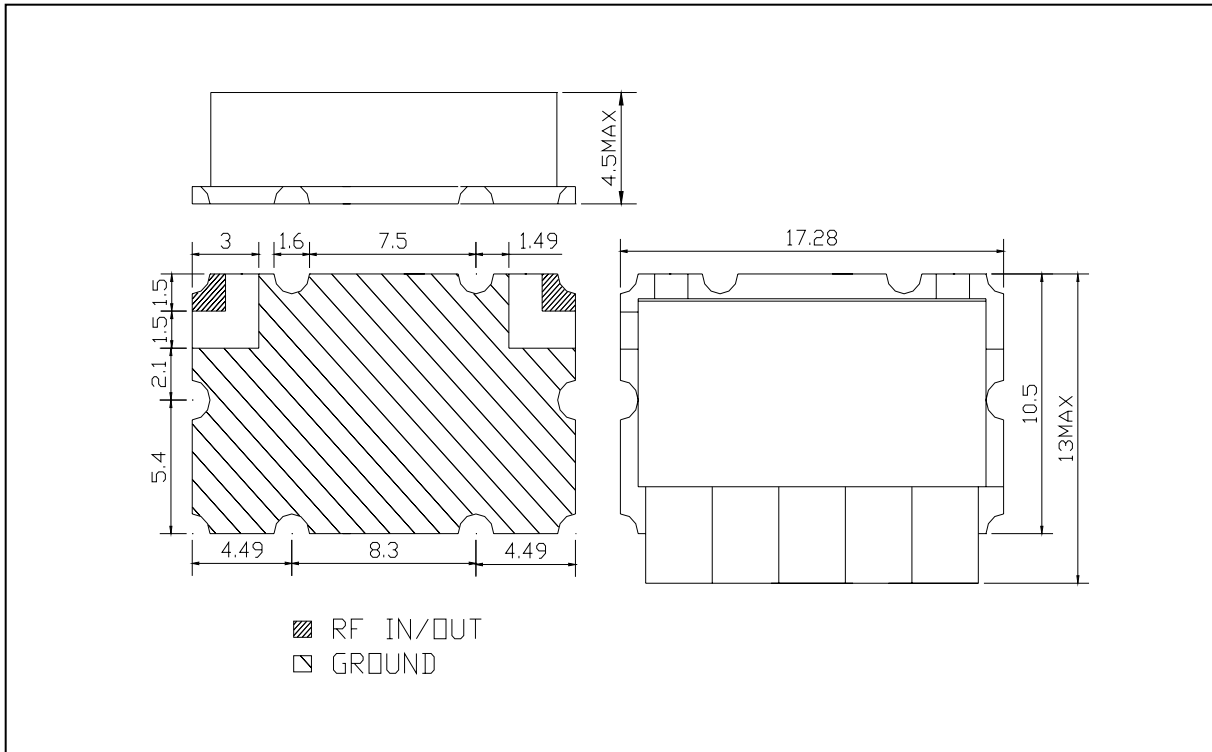
S21 LOG MAG NETWORK ANALYZER



S11 LOG MAG NETWORK ANALYZER



## 5. DIMENSIONS



## □ MATERIAL SPECIFICATION

1. PCB
  - 1) MATERIAL: FR4
  - 2) TERMINALS: Sn/Pb, HASL
2. METAL CASE
  - 1) Ag or Sn or Ni plated brass
3. RESONATOR
  - 1) COATING MATERIAL: silver plate, 8~30um
4. INTERNAL SOLDER
  - 1) Sn96.5/Ag3.5 Lead Free solder,  
221 deg C melting
5. RESONATORS TABS
  - 1) Sn/Pb(9:1) Plated or Ag brass
6. NO PURE TIN ALLOWED

## ✕ MARKING

Label Material: High temp polyimide

Marking:  
**CF-13201005**

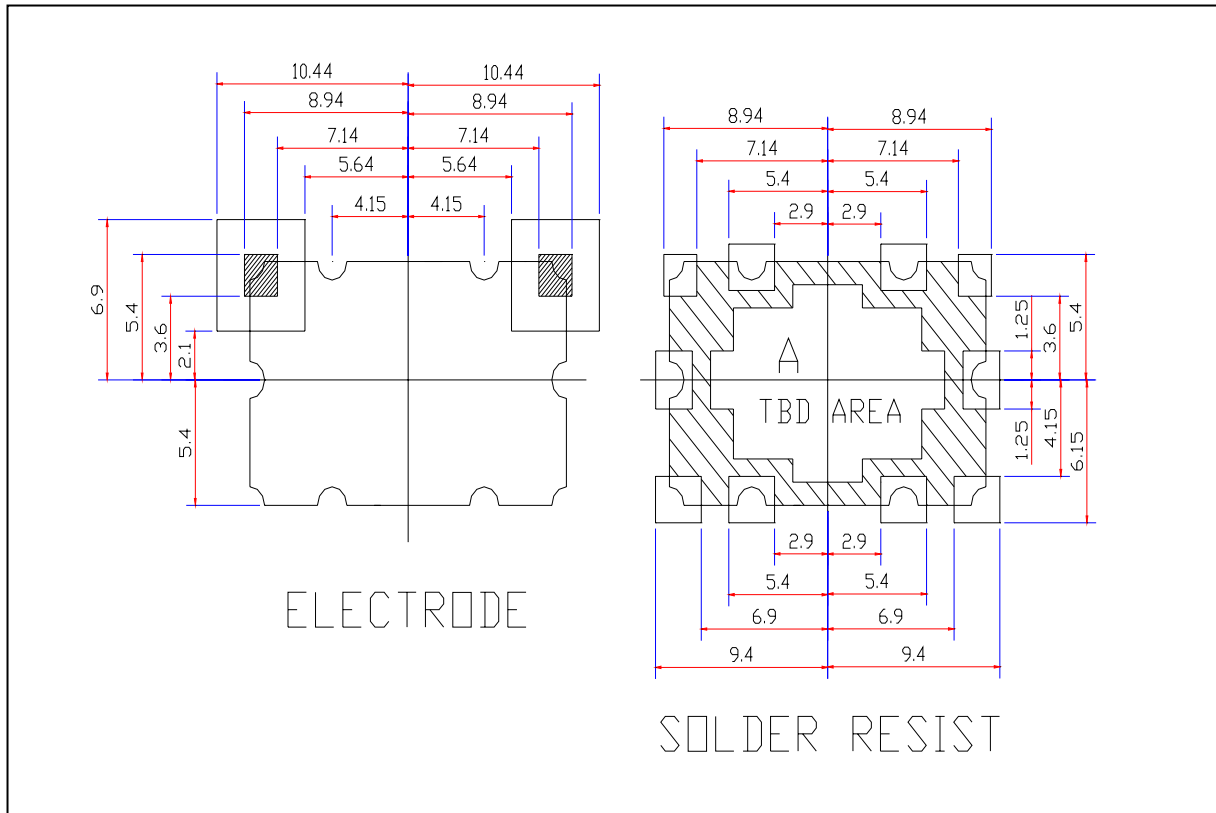
Filtronetics  
Date Code

UNIT: MM  
TOLERANCE: +/-0.5MM  
IN/OUT LAND : +/-0.3MM

## CAUTIONS:

1. When handling products, be careful not to damage the outer-electrode.
2. When handling products be careful not to touch the outer-electrode with bare hands or solder-ability is reduced.
3. Do not apply excessive pressure or shock to product in handling or in transportation or damage to the ceramic filters may result.

**Recommended Solder Pattern:**

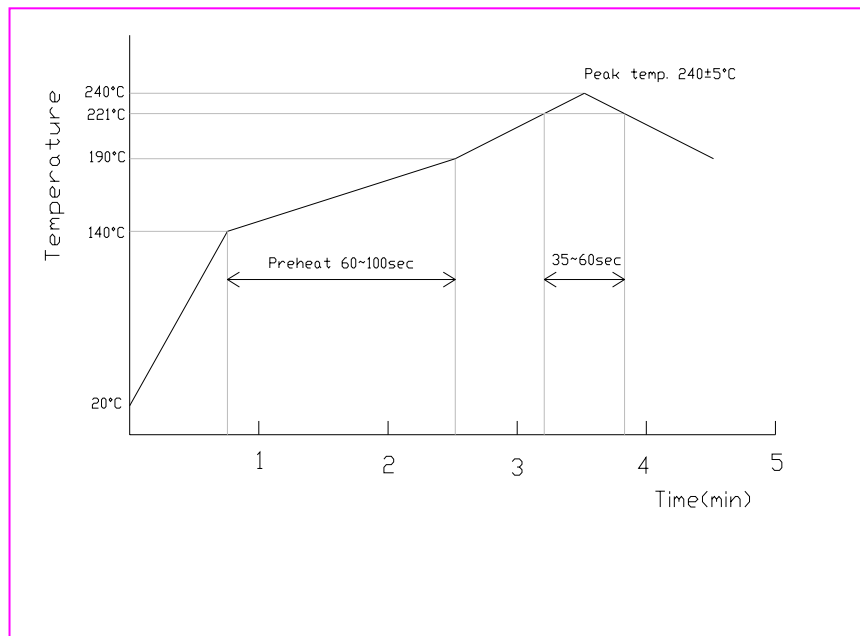


| <b>Quality Conformance Test 100% Final inspection</b><br><b>100% Test Data</b> |   |
|--|---|
| 1)   | Visual mechanical to IPC-610 Class 3<br>Including inspection for cleanliness. |
| 2)   | Thermal Shock -44 to +85°C 10 cycles  |
| 3)   | Electrical Specifications at ambient  |

6. DEFINITIONS

| TERMS                | DESCRIPTION  | SPECIFICATION    |
|----------------------|--|------------------|
| Center Frequency     | The midpoint of through band pass filter pass band, normally expressed as the arithmetic mean of the -3db point. Also called fo.                                 | 3. SPECIFICATION |
| Pass Band Width      | The width of the pass band of a filter referenced to the minimum insertion loss point in the pass band. The pass band of a filter is stated as -3.0dB bandwidth. |                  |
| Insertion Loss       | The loss of the filter, in db, measured at center frequency relative to a through line (0 dB).   |                  |
| Attenuation          | Reduction of RF power through a filter measured in dB, at desired band and referenced to 0 dB. (Filter to be removed from circuit)                               |                  |
| Pass Band Ripple     | Variations in loss in the pass band of the filter, superimposed upon the fundamental shape of the pass band.   |                  |
| V.S.W.R in Pass Band | The ratio of the maximum value of a standing wave to its minimum value, related to the return loss in pass band.   |                  |

7. REFLOW SOLDERING STANDARD CONDITIONS



- Measuring point of temperature in-out terminals of the device.
- Reflow Soldering
- Both convection and infrared rays
- Hot air
- Solder Cream: Sn96.5/Ag3.5

## 8. RELIABILITY TEST AND CONDITIONS

| ITEM                                    | TEST CONDITIONS  | REQUIREMENTS   |
|---|--|--|
| Resistance to solder heat               | Preheat temperature : 120 to 150°C<br>Preheat time: 1 to 1.5 min<br>Solder temperature: 260 +/- 10°C<br>Dipping time: 10 +/- 0.5 sec<br><b>→Soldering Time : 5sec.max.per each terminal</b>  | No damage such as cracks should be caused in chip element.   |
| Solderability                           | Preheat temperature: 120 to 150°C<br>Preheat time: 1 to 1.5 min<br>Solder temperature: 235 +/- 5°C<br>Dipping time: 5 +/- 1 sec  | More than 80% of the terminal electrode shall be covered with new solder   |
| Heat resistance (High-temperature Load) | Temperature: 85 +/- 2°C<br>Applied voltage: Rated voltage<br>Applied current: Rated current<br>Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.   | No mechanical damage. After test, the device shall satisfy the specification in section 3.<br><b>Standard condition is 25+/-5°Cand Less than 65% relative humidity</b> |
| Thermal shock (Temperature cycle)       | Conditions for 1 cycle<br>Step 1: + 85°C 15 min<br>Step 2 : - 44°C 15 min<br>Number of cycle: 10   | No mechanical damage. After test, the device shall satisfy the specification in section 3.   |
| Humidity Resistance                     | Temperature: 40 +/- 2°C<br>Humidity: 90 to 95% RH<br>Duration: 96 +/- 5 hrs<br>Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.   | No mechanical damage. After test, the device shall satisfy the specification in section 3.   |
| Vibration                               | The device is subjected to vibration of 2 sweeps in each of three mutually perpendicular planes<br>Frequency shall be varied within 10~50Hz with 1.5mm double amplitude and within 50~500 Hz With 10G's acceleration. Sweep time of Frequency Shall be 15minutes | No mechanical damage. After test, the device shall satisfy the specification in section 3.   |
| Shock                                   | The device is subjected to 3 shocks in each direction of six mutually perpendicular planes Each shock shall be a half-sine wave shaped with a magnitude of 30G's and a duration of 11msec.   | No mechanical damage. After test, the device shall satisfy the specification in section 3.   |